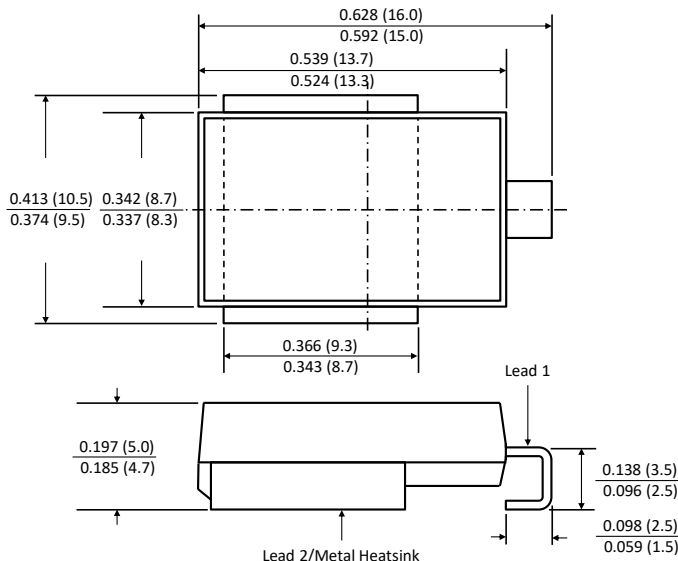


### DO-218 Package



Dimension in inches and (millimeter)

PRIMARY CHARACTERISTICS	
VRWM	16V to 43V
VBR	17.8V to 52.8V
PPPM (10/1000us)	3600W
TJ max	175°C
Polarity	Uni-directional & Bi-directional
Package	DO-218

### FEATURES

- Glass passivated junction technology
- Low forward voltage drop for Uni-directional polarity
- Fast response time: typical less than 1.0ps from 0 Volts to BV
- TJ = 175°C capability suitable for high reliability
- High surge capability
- Maximum peak power dissipation: 3600 Watts
- Meets ISO7637-2 & ISO16750-2 surge specification (varied by test condition)
- Halogen-Free
- RoHS compliant
- AEC-Q101 qualified



### MECHANICAL DATA

**Case:** DO-218. Molded plastic over glass passivated junction Molding compound meets UL 94V-0 flammability rating

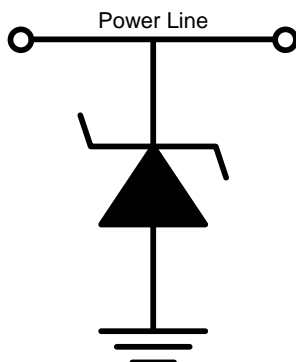
**Terminal:** Solderable per MIL-STD-750, Method 2026

**Polarity:** Heat sink is anode, Color band denoted positive end (cathode) except Bidirectional.

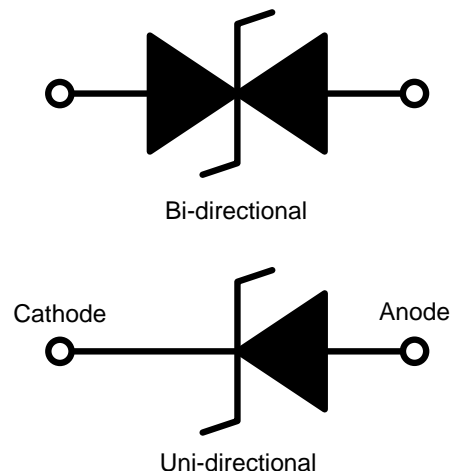
### Typical Application

Use in sensitive electronics protection against voltage transients induced by inductive load switching and lighting. Especially for automotive load dump protection application.

### Typical Application



### Functional Diagram



## Ordering Information

Part Number	Quantity	Packing Option	Component Package	Packing Specification
ALD5SxxA	750	Tape & Reel - 24mm/13" tape	DO-218	EIA STD RS-481



AOS products are offered in packages with Pb-free plating and compliant to RoHS standards. Please visit <https://aosmd.com/sites/default/files/media/AOSGreenPolicy.pdf> for additional information.

## MAXIMUM RATINGS (25°C ambient temperature unless otherwise specified)

Parameter	Symbol	Value	Unit
Peak Pulse Power Dissipation on 10/1000µs waveform <sup>(1)</sup>	PPPM	3600	Watts
Peak Pulse Power Dissipation on 10/10000µs waveform <sup>(1)</sup>	PPPM	2800	Watts
Peak Pulse Current of on 10/1000µs waveform	I <sub>PPM</sub>	See next table	Amps
Power dissipation on infinite heatsink (T <sub>C</sub> = 25°C)	P <sub>D</sub>	5	Watts
Peak Forward Surge Current, 8.3ms Single Half Sine-Wave, Superimposed on Rated Load. (JEDEC Method)	I <sub>FSM</sub>	500	Amps
Operating junction and Storage Temperature Range	T <sub>J</sub> T <sub>STG</sub>	-55 to +175	°C

**Note:**

1. Non-repetitive current pulse above T<sub>A</sub> = 25 °C

## ELECTRICAL CHARACTERISTICS

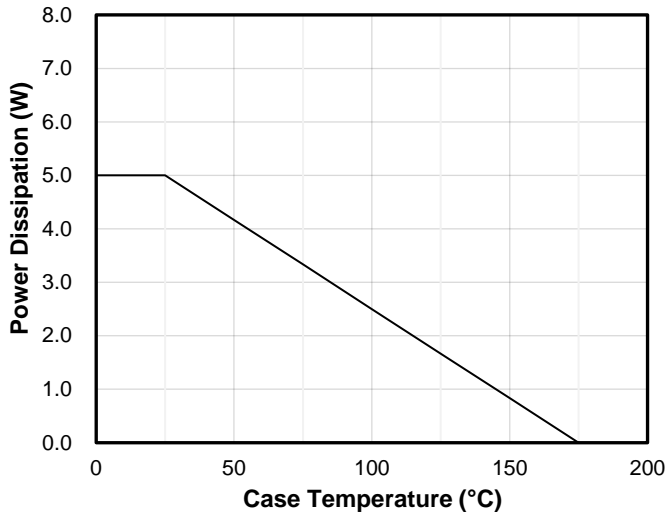
PART NUMBER		REVERSE STAND-OFF VOLTAGE VRWM(V)	BREAKDOWN VOLTAGE VBR(V) @IT		TEST CURRENT I <sub>r</sub> (mA)	MAXIMUM CLAMPING VOLTAGE @I <sub>pp</sub> V <sub>c</sub> (V)	MAXIMUM PEAK PULSE CURRENT I <sub>pp</sub> (A)	MAXIMUM REVERSE LEAKAGE @ VRWM I <sub>R</sub> (µA)
UNI- POLAR	BI-POLAR		MIN	MAX				
ALD5S16A	ALD5S16CA	16.0	17.80	19.70	5	26.0	138.5	10
ALD5S17A	ALD5S17CA	17.0	18.90	20.90	5	27.6	130.5	10
ALD5S18A	ALD5S18CA	18.0	20.00	22.10	5	29.2	123.5	10
ALD5S20A	ALD5S20CA	20.0	22.20	24.50	5	32.4	111.5	10
ALD5S22A	ALD5S22CA	22.0	24.40	26.90	5	35.5	101.5	10
ALD5S24A	ALD5S24CA	24.0	26.70	29.50	5	38.9	93.0	10
ALD5S26A	ALD5S26CA	26.0	28.90	31.90	5	42.1	86.0	10
ALD5S28A	ALD5S28CA	28.0	31.10	34.40	5	45.4	79.5	10
ALD5S30A	ALD5S30CA	30.0	33.30	36.80	5	48.4	74.5	10
ALD5S33A	ALD5S33CA	33.0	36.70	40.60	5	53.3	68.0	10
ALD5S36A	ALD5S36CA	36.0	40.00	44.20	5	58.1	62.0	10
ALD5S40A	ALD5S40CA	40.0	44.40	49.10	5	64.5	56.0	10
ALD5S43A	ALD5S43CA	43.0	47.80	52.80	5	69.4	52.0	10

**Note:**

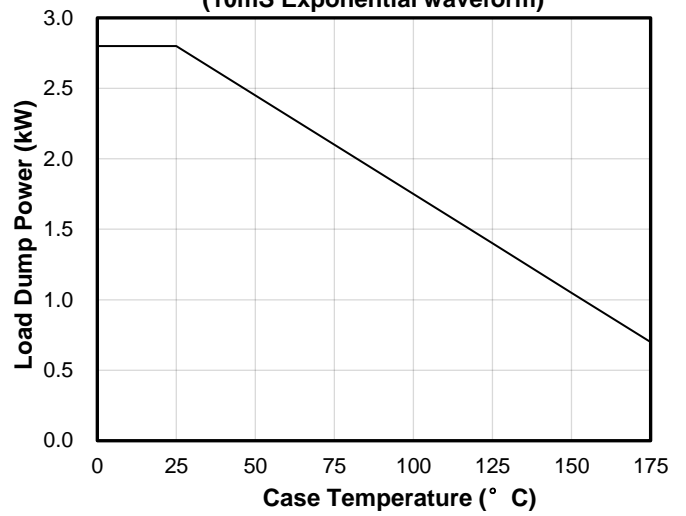
For uni-directional part, the maximum V<sub>F</sub> = 1.8 V at I<sub>F</sub> = 100 A measured on 8.3ms single half sine-wave or equivalent square wave, duty cycle = 4 pulses per minute maximum

**RATINGS AND CHARACTERISTICS CURVES ( $T_A = 25^\circ\text{C}$  unless otherwise noted)**

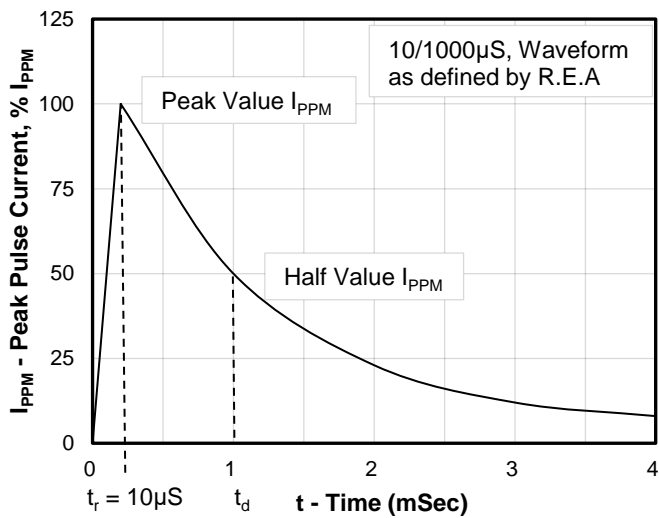
**Power De-Rating Curve**



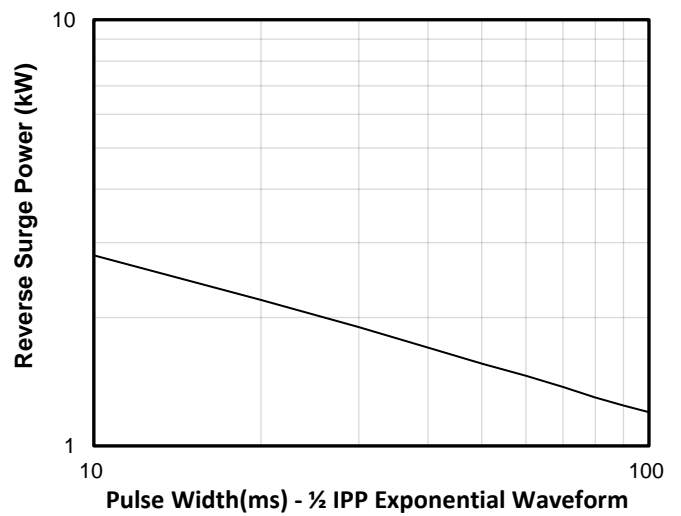
**Load Dump Power Characteristics (10mS Exponential waveform)**



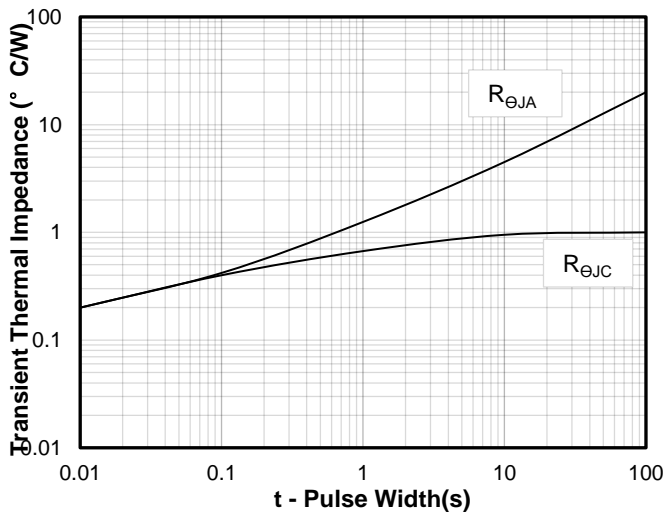
**Pulse Waveform**



**Reverse Power Capability**



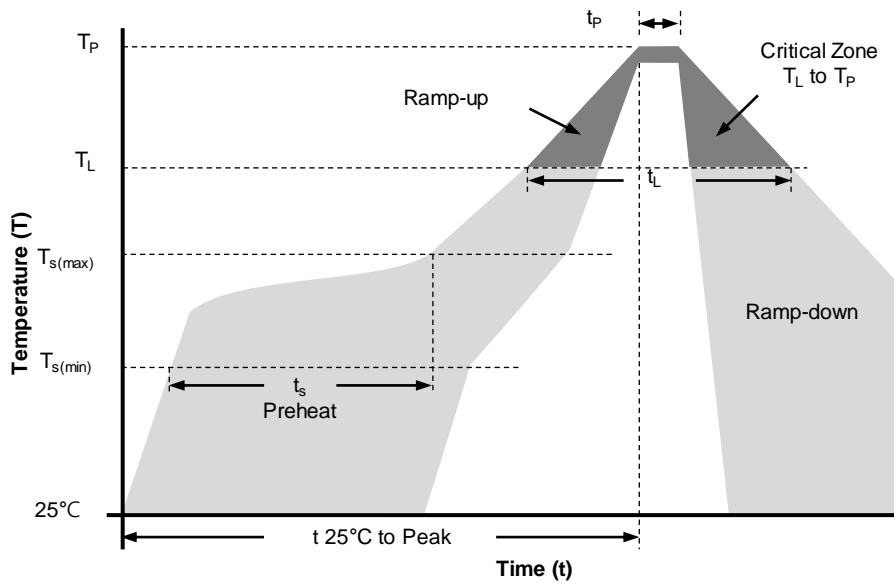
**Typical Transient Thermal Impedance**



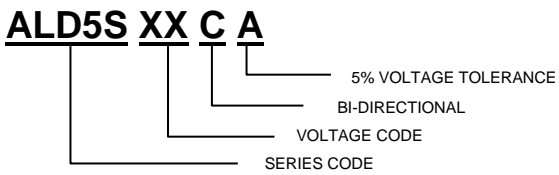
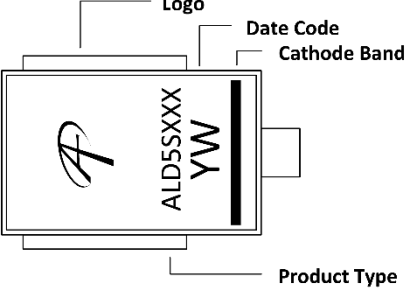
### Soldering Parameters

Reflow Condition		Lead-free assembly
Pre Heat	-Temperature Min ( $T_{s(min)}$ )	150°C
	-Temperature Max ( $T_{s(max)}$ )	200°C
	-Time (min to max) ( $t_s$ )	60-120 seconds
Average ramp up rate (Liquidus Temp( $T_L$ ) to peak)		3°C/second max
$T_{s(max)}$ to $T_L$ - Ramp-up Rate		3°C/second max
Reflow	-Temperature Min ( $T_L$ )	217°C
	Time ( $t_L$ ) maintained above $T_L$	60-150 seconds
Peak temperature( $T_P$ )		245 $\pm 0/-5$ °C
Time within 5°C of actual peak Temperature( $t_p$ )		20-40 seconds
Ramp-down Rate		6°C/second max
Time 25°C to peak temperature( $T_P$ )		8 minutes max

### Soldering Profile



**PART MARKING**

Part Number	Part Marking
 <p><b>ALD5S XX C A</b></p> <ul style="list-style-type: none"> <li>ALD5S: SERIES CODE</li> <li>XX: VOLTAGE CODE</li> <li>C: BI-DIRECTIONAL</li> <li>A: 5% VOLTAGE TOLERANCE</li> </ul>	 <p>ALD5S series</p>

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